

SHINDENGEN

VZ Series Power MOSFET

N-Channel Enhancement type

2SK2492
(F20F18VZ)

180V 20A

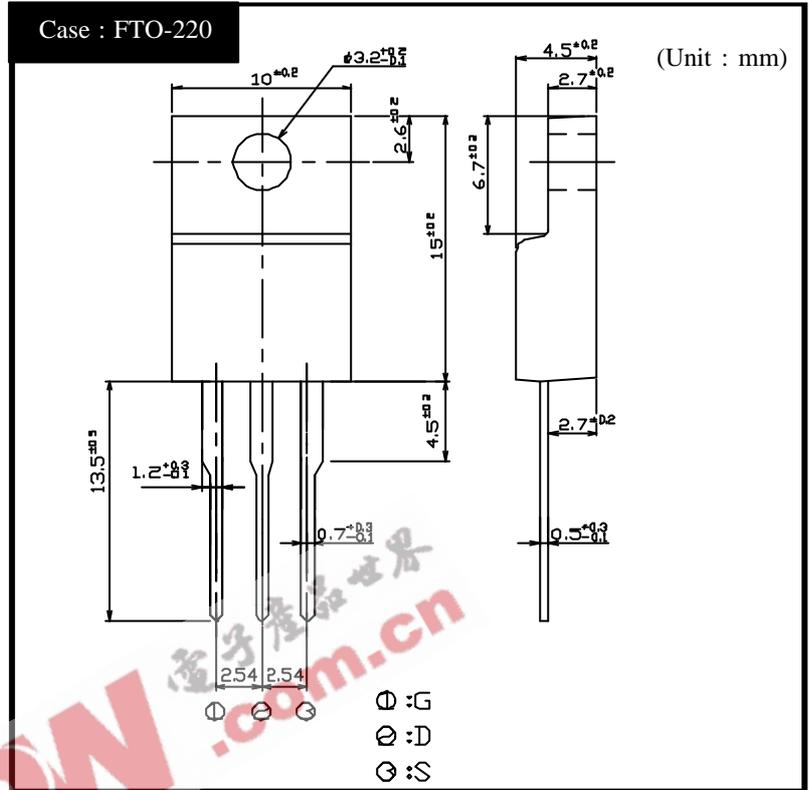
FEATURES

Input capacitance (Ciss) is small.
Especially, input capacitance at 0 bias is small.
The static Rds(on) is small.
The switching time is fast.

APPLICATION

DC/DC converters
Power supplies of DC 12-24V input
Product related to
Integrated Service Digital Network

OUTLINE DIMENSIONS



RATINGS

Absolute Maximum Ratings (Tc = 25)

| Item | Symbol | Conditions | Ratings | Unit |
|---------------------------------|------------------|-------------------------------|-----------|------|
| Storage Temperature | T _{stg} | | -55 ~ 150 | |
| Channel Temperature | T _{ch} | | 150 | |
| Drain-Source Voltage | V _{DSS} | | 180 | V |
| Gate-Source Voltage | V _{GSS} | | ± 30 | |
| Continuous Drain Current (DC) | I _D | | 20 | A |
| Continuous Drain Current (Peak) | I _{DP} | | 40 | |
| Continuous Source Current (DC) | I _S | | 20 | |
| Total Power Dissipation | P _T | | 60 | W |
| Single Pulse Avalanche Current | I _{AS} | T _{ch} = 25 | 20 | A |
| Mounting Torque | TOR | (Recommended torque 0.3 N·m) | 0.5 | N·m |

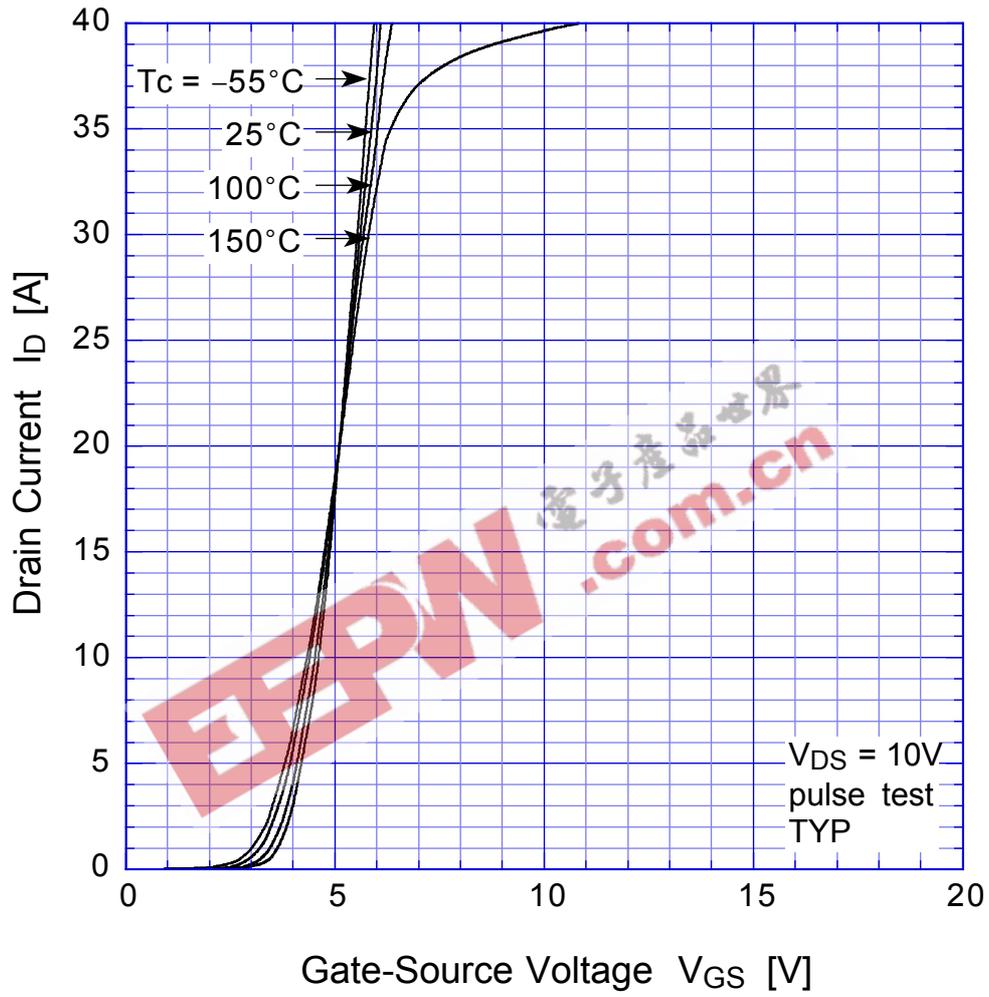
●Electrical Characteristics $T_c = 25^\circ\text{C}$

| Item | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|---------------|---|------|------|-----------|---------------------------|
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $I_D = 1\text{mA}, V_{GS} = 0\text{V}$ | 180 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 180\text{V}, V_{GS} = 0\text{V}$ | | | 250 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$ | | | ± 0.1 | |
| Forward Transconductance | g_{fs} | $I_D = 10\text{A}, V_{DS} = 10\text{V}$ | 8 | 15 | | S |
| Static Drain-Source On-state Resistance | $R_{DS(ON)}$ | $I_D = 10\text{A}, V_{GS} = 10\text{V}$ | | 0.08 | 0.13 | Ω |
| Gate Threshold Voltage | V_{TH} | $I_D = 1\text{mA}, V_{DS} = 10\text{V}$ | 2.0 | 3.0 | 4.0 | V |
| Source-Drain Diode Forward Voltage | V_{SD} | $I_S = 10\text{A}, V_{GS} = 0\text{V}$ | | | 1.5 | |
| Thermal Resistance | θ_{jc} | junction to case | | | 2.08 | $^\circ\text{C}/\text{W}$ |
| Total Gate Charge | Q_g | $V_{DD} = 150\text{V}, V_{GS} = 10\text{V}, I_D = 20\text{A}$ | | 55 | | nC |
| Input Capacitance | C_{iss} | $V_{DS} = 10\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$ | | 1600 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 190 | | |
| Output Capacitance | C_{oss} | | | 650 | | |
| Turn-On Time | t_{on} | $I_D = 10\text{A}, V_{GS} = 10\text{V}, R_L = 10\Omega$ | | 95 | 190 | ns |
| Turn-Off Time | t_{off} | | | 300 | 600 | |

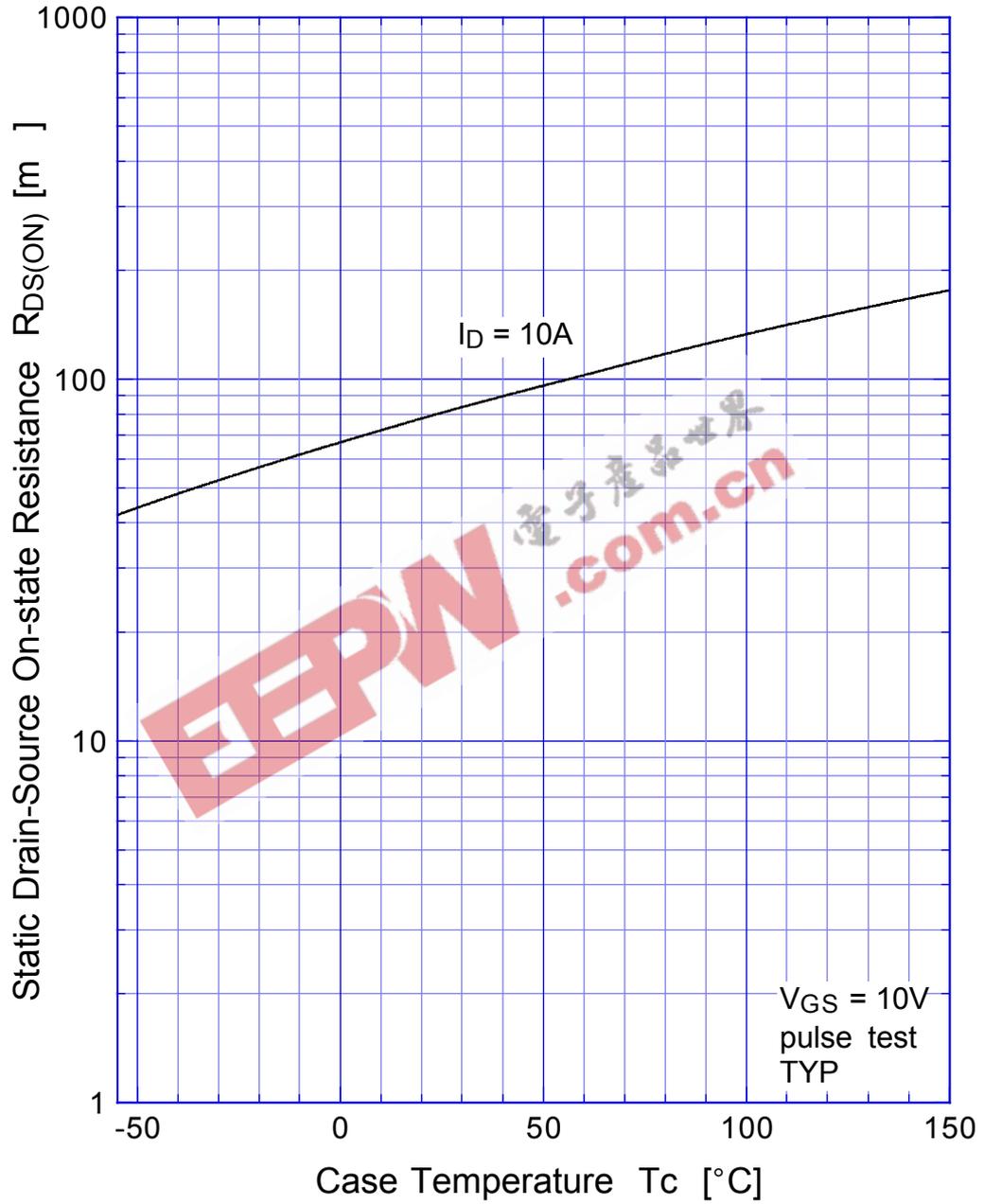
EEPW 电子产品世界
.com.cn

2SK2492

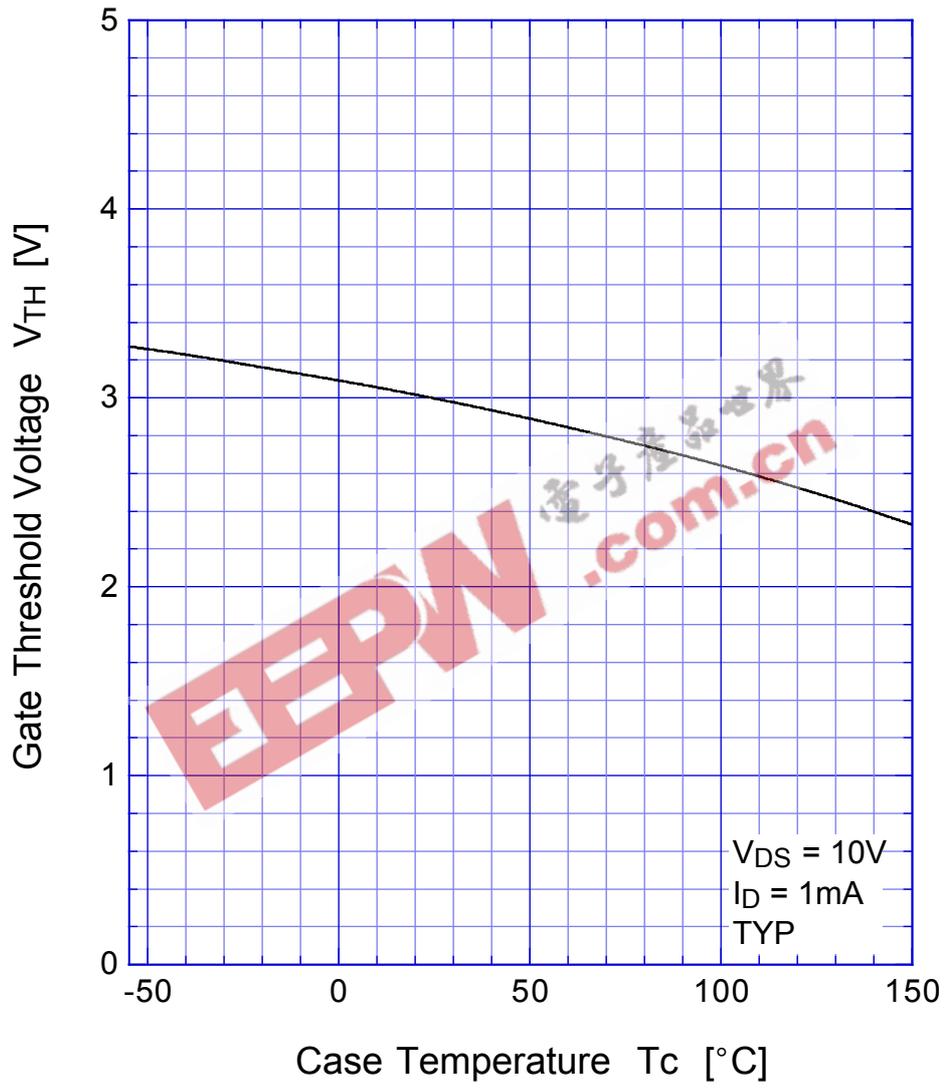
Transfer Characteristics



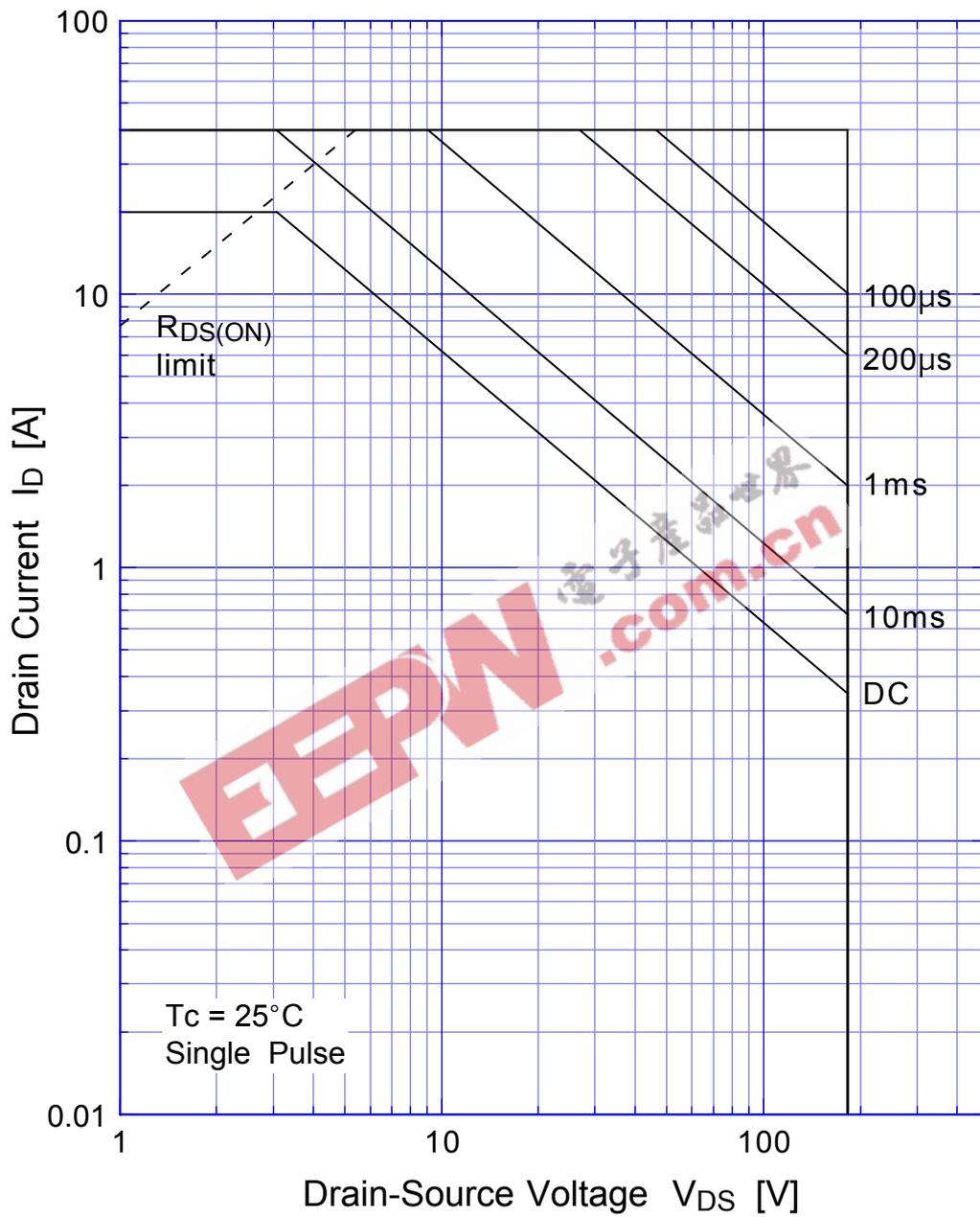
2SK2492 Static Drain-Source On-state Resistance



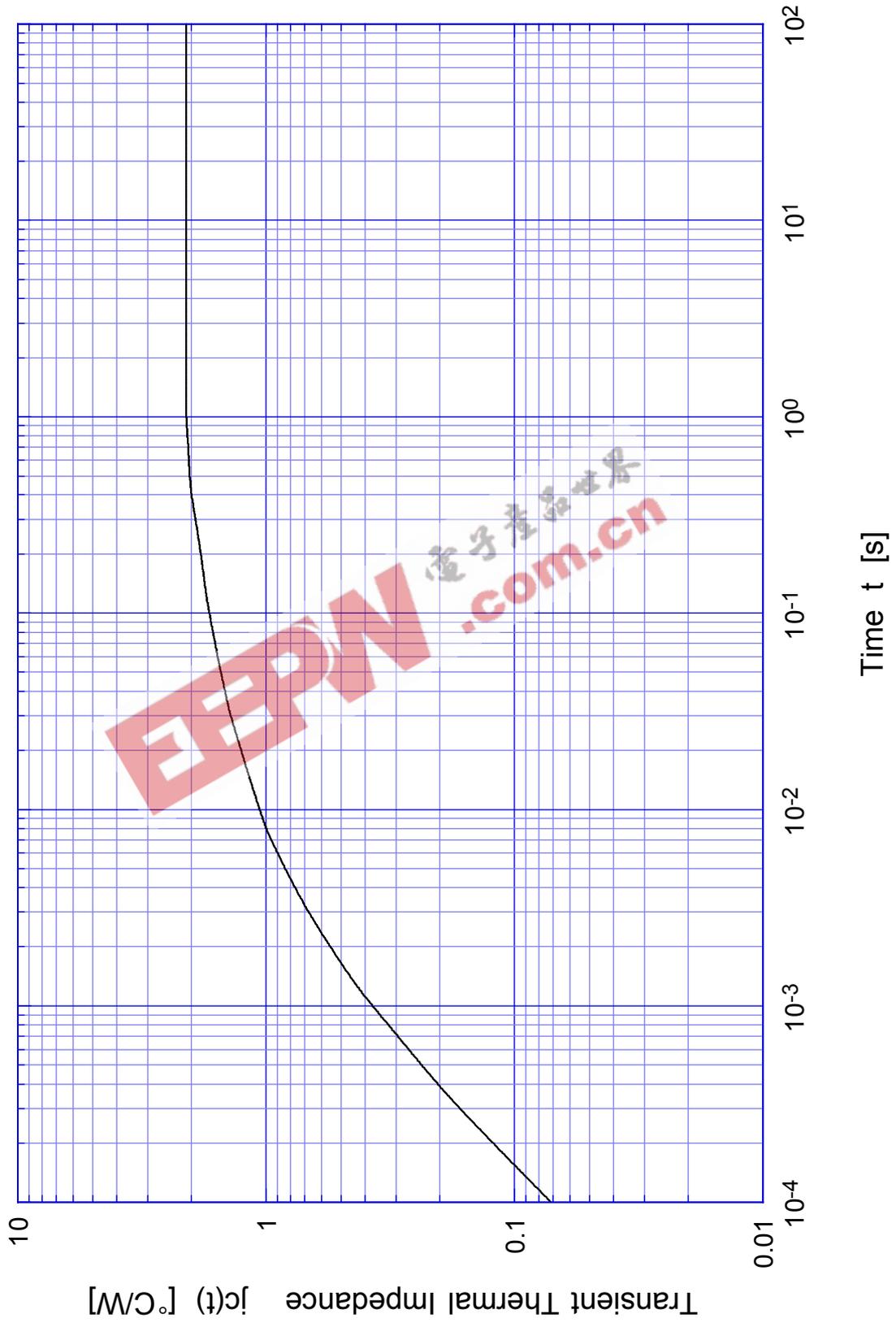
2SK2492 Gate Threshold Voltage



2SK2492 Safe Operating Area

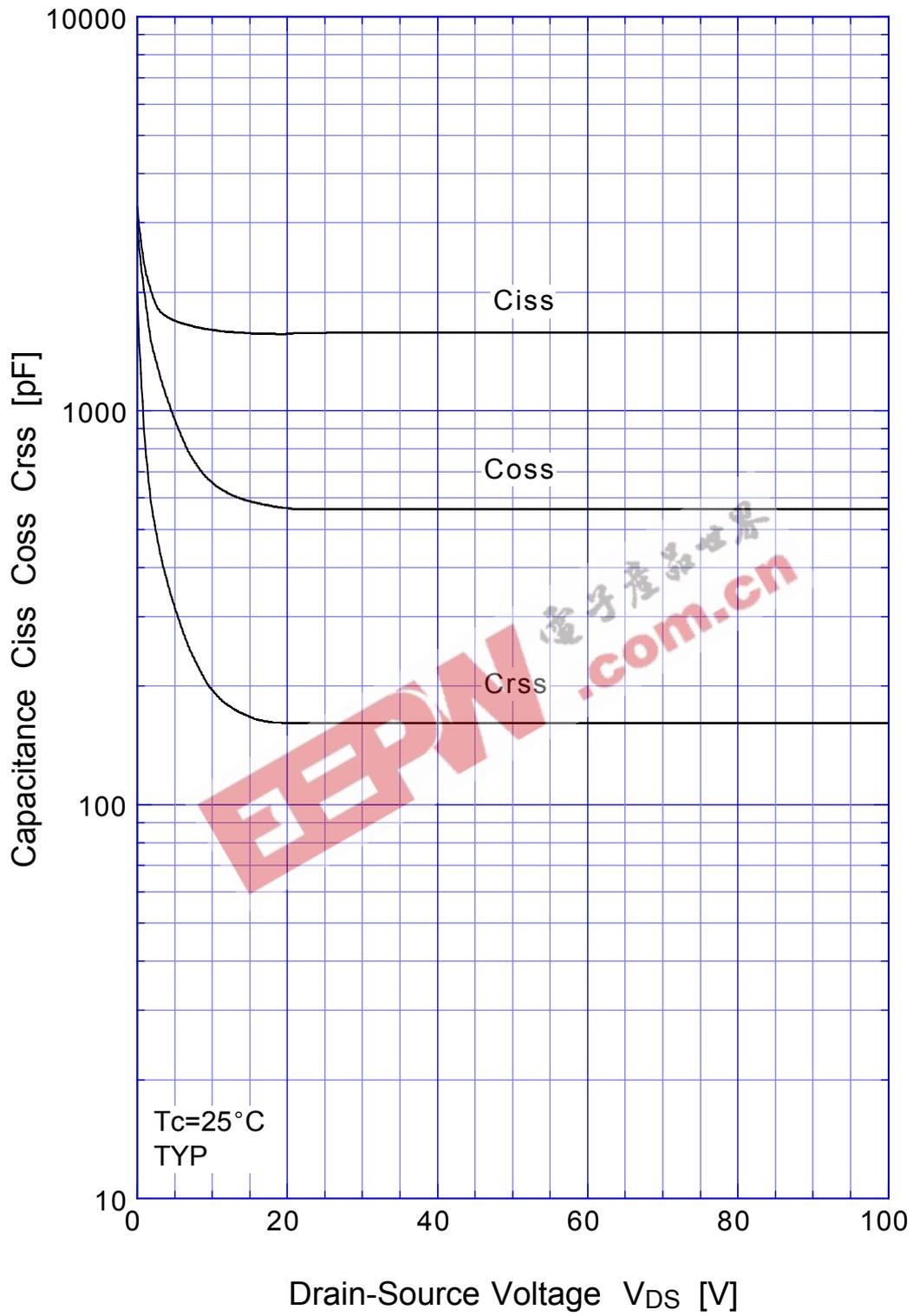


2SK2492 Transient Thermal Impedance



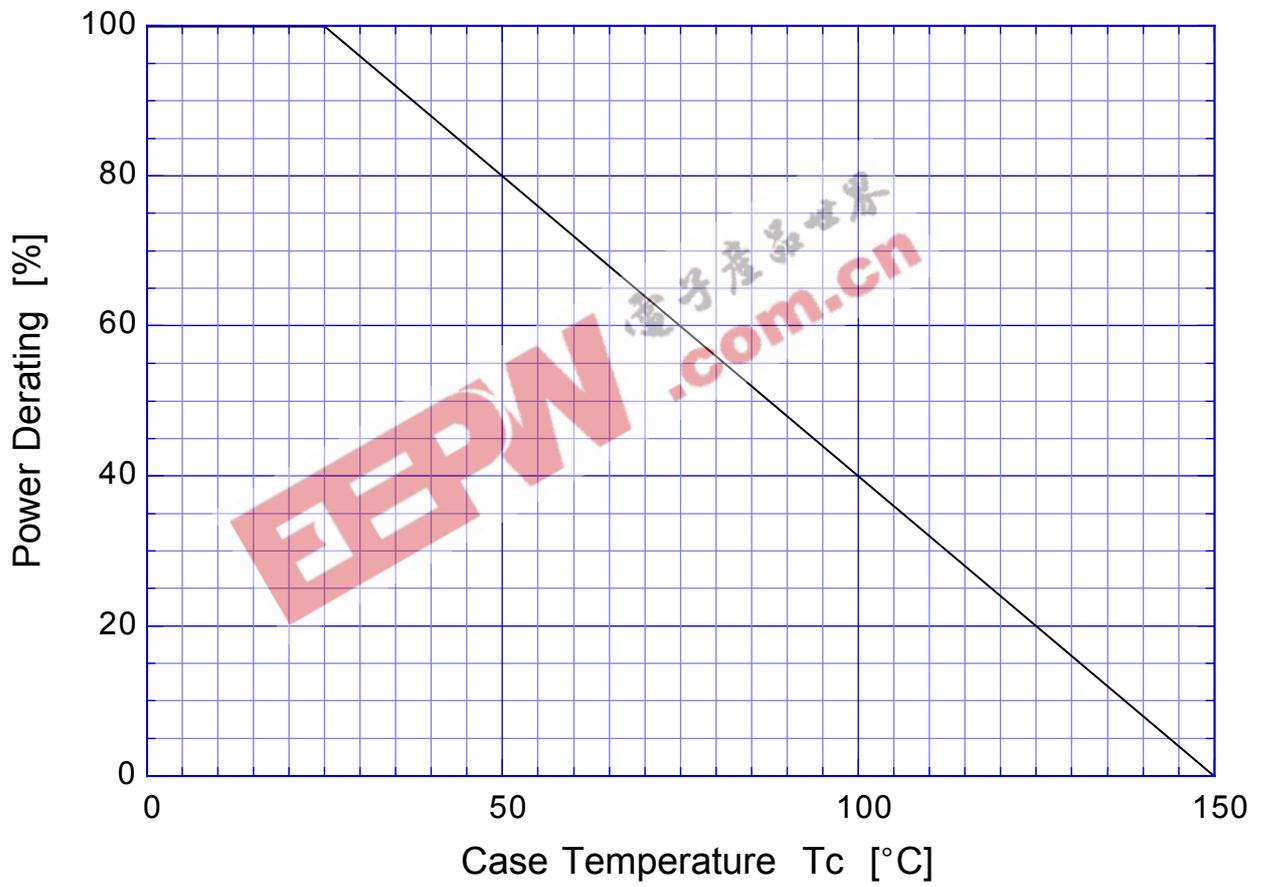
2SK2492

Capacitance



2SK2492

Power Derating



2SK2492 Gate Charge Characteristics

